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LED DISPLAY

LTP-4824CTB-P DATA SHEET

ITEM	Description	By	DATE
1.	New Spec	Reo Lin	2012/11/02

PART NO.: LTP-4824CTB-P

FEATURES

* 0.4 inch (10.16 mm) DIGIT HEIGHT * CONTINUOUS UNIFORM SEGMENTS * LOW POWER REQUIREMENT * EXCELLENT CHARACTERS APPEARANCE * HIGH BRIGHTNESS & HIGH CONTRAST * WIDE VIEWING ANGLE * SOLID STATE RELIABILITY * CATEGORIZED FOR LUMINOUS INTENSITY * SMD DISPLAY * LEAD-FREE PACKAGE (ACCORDING TO RoHS)

DESCRIPTION

The LTP-4824CTB-P is a 0.4 inch (10.16 mm) digit height single digit alphanumeric display. This device uses InGaN blue LED chips (InGaN epi on Sapphire substrate). The display has gray face and white segments.

DEVICE

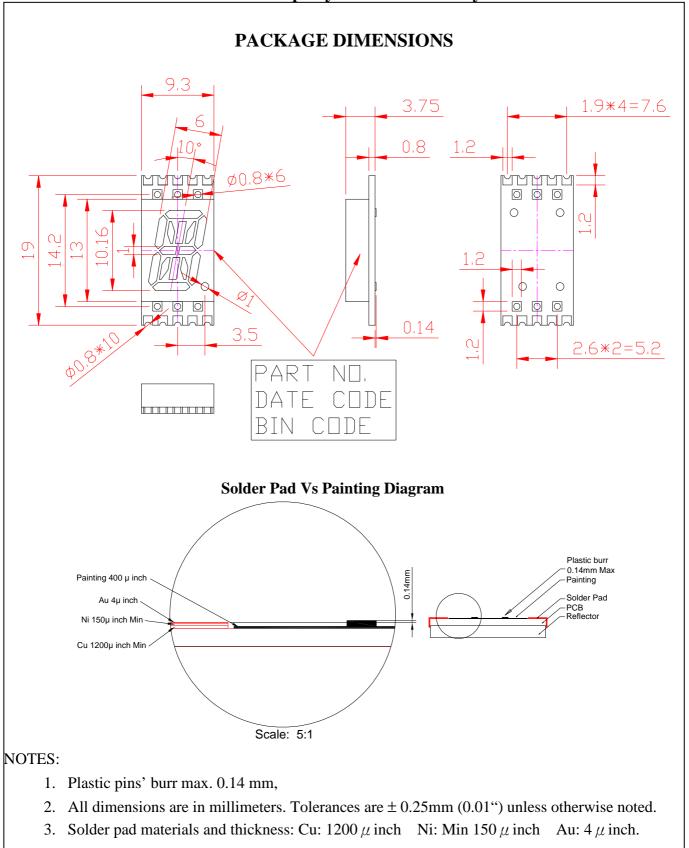
PART NO.	DESCRIPTION	
InGaN Blue	Common Anode	
LTP-4824CTB-P		

PART NO.: LTP-4824CTB-P



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INTERNAL CIRCUIT DIAGRAM

		14 j j j 15 13	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$		
	PIN CONNECTION				
No.	CONNECTION	No.	CONNECTION		
1			Cathode g		
2	Cathode n	10	Cathode a		
3	Cathode m	11	Cathode b		
4	Cathode 1	12 13	Cathode k		
5			Cathode j		
6	Cathode c		Common Anode		
7	Cathode d	15	Cathode h		

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Cathode e

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Cathode f

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BNS-OD-C131/A4

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ABSOLUTE MAXIMUM RATING

PARAMETER	MAXIMUM RATING	UNIT	
Power Dissipation Per Segment	70	mW	
Peak Forward Current Per Segment (Frequency 1Khz, 10% duty cycle)	30	mA	
Continuous Forward Current Per Segment	25	mA	
Forward Current Derating from 25°C	0.33	mA/°C	
Operating Temperature Range	-35°C to +85°C		
Storage Temperature Range -35°C to +85°C			
Soldering Conditions : $1/16$ inch below seating plane for 3 seconds at 260° C			

ELECTRICAL / OPTICAL CHARACTERISTICS

	Т			1		1
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITION
Average Luminous Intensity Per Segment	Iv	1300	5600		μcd	IF=10mA
Peak Emission Wavelength	λp		468		nm	IF=20mA
Spectral Line Half-Width	$\Delta\lambda$		25		nm	IF=20mA
Dominant Wavelength	λd		470		nm	IF=20mA
Forward Voltage Per Segment	VF		3.3	3.8	V	IF=20mA
Reverse Current Per Segment ⁽²⁾	Ir			100	μA	Vr=5V
Luminous Intensity Matching Ratio	Iv-m			2:1		IF=1mA

Note:

- 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE (Commision Internationale De L'Eclairage) eye-response curve.
- 2. Reverse voltage is only for IR test. It can not continue to operate at this situation.
- 3. Cross talk specification $\leq 2.5\%$

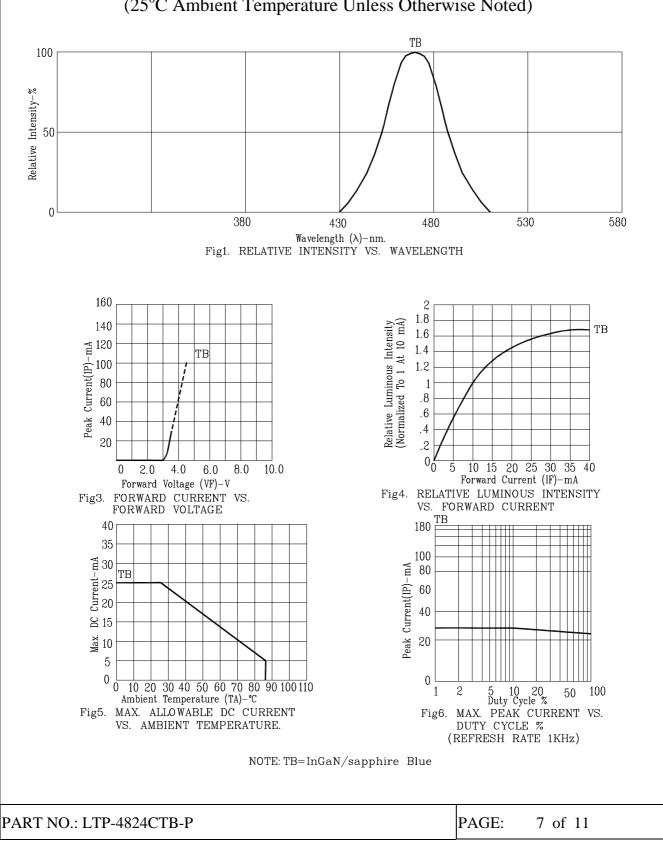
PART NO.: LTP-4824CTB-P

ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED. Suggestions to prevent ESD damage:

- Use of a conductive wrist band or anti-electrostatic glove when handling these LEDs.
- All devices, equipment, and machinery must be properly grounded.
- Work tables, storage racks, etc. should be properly grounded.
- Use ion blower to neutralize the static charge which might have built up on surface of the LED's plastic for N/D as a result of friction between LEDs during storage and handling.

TYPICAL ELECTRICAL / OPTICAL CHARACTERISTIC CURVES



(25°C Ambient Temperature Unless Otherwise Noted)

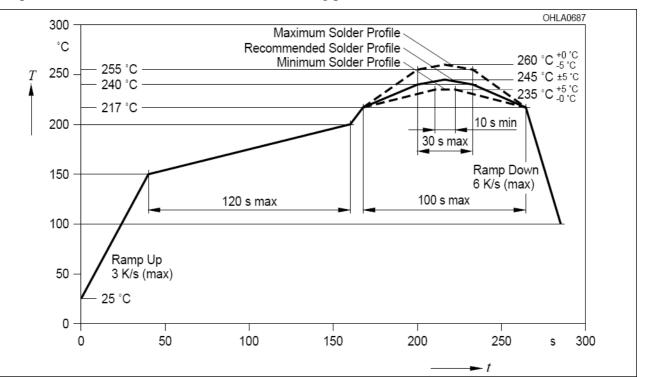


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SMT SOLDERING INSTRUCTION

(Number of reflow process shall be less than 2 times, and cooling process to normal temperature is required between the first and the second soldering process)



Note:

1. Recommended soldering condition:

Reflow Soldering (Two times only)		Soldering Iron (One time only)		
Pre-heat:	120~150°C.	Temperature	300°C Max.	
Pre-heat time:	120sec. Max.	Soldering time	3sec. Max.	
Peak temperature:	260°C Max.			
Soldering time:	5sec. Max.			

2. Number of reflow process shall be less than 2 times, and cooling process to normal temperature is required between the first and the second soldering process.

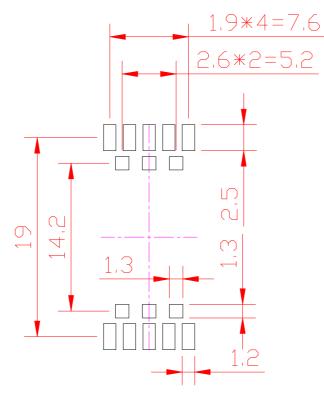
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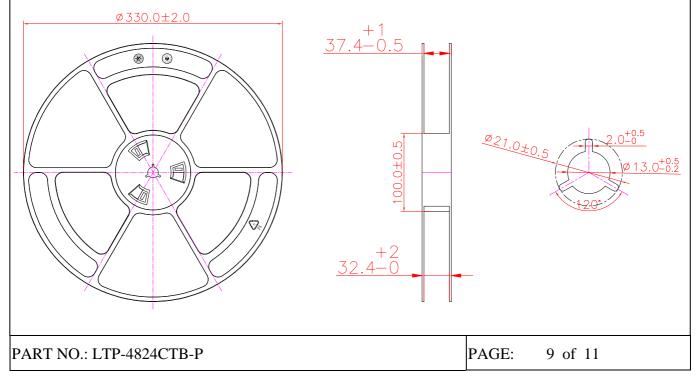
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RECOMMENDED SOLDERING PATTERN



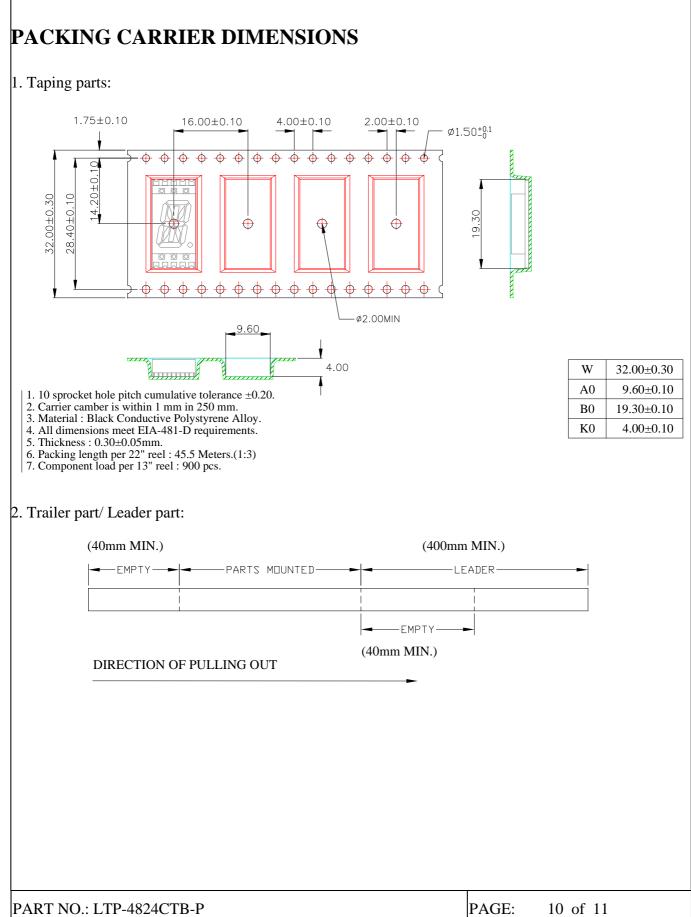
Note: All dimensions are in millimeters.

PACKING REEL DIMENSIONS



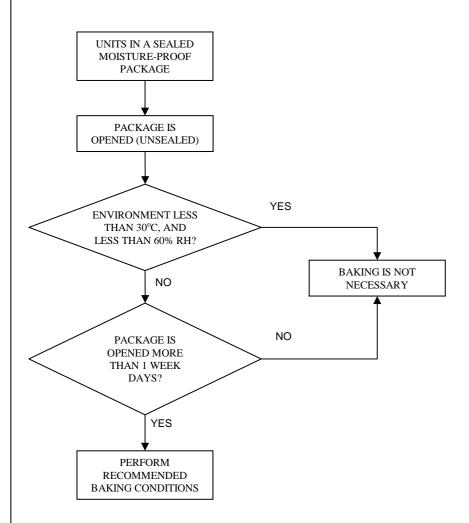
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Moisture Proof Packaging

All N/D SMD displays are shipped in moisture proof package. The displays should be stored at 30°C or less and 90% RH or less. Once the package opened, moisture absorption begins.



Baking Conditions

If the parts are not stored in dry conditions, they must be baked before reflow to prevent damage to the parts.

Package	Temperature	Time
In Reel	60 ° C	\geq 48hours
In Bulk	100°C	\geq 4hours
	125°C	\geq 2hours

Baking should only be done once.

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